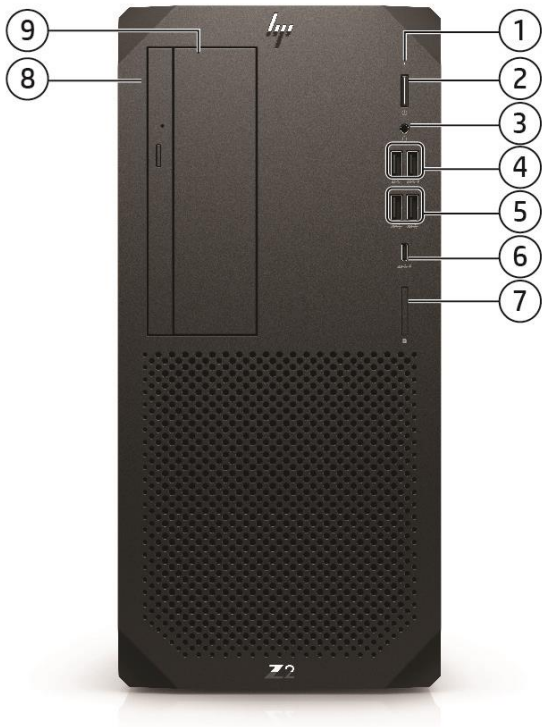
Overview

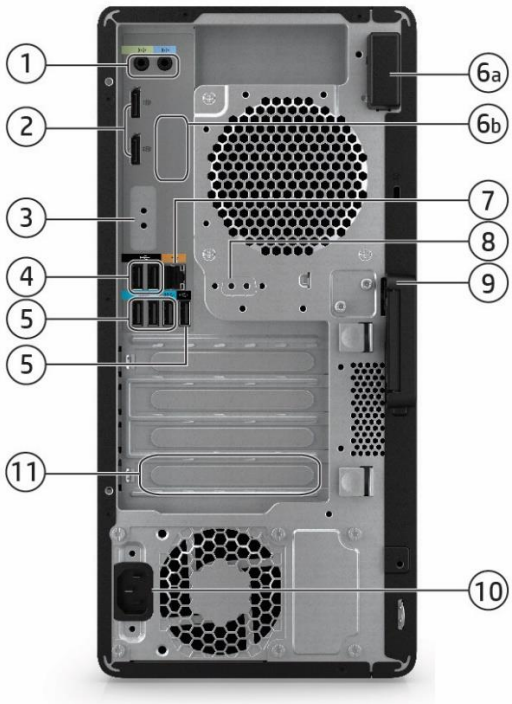
HP Z2 G9 Tower Workstation Desktop PC



front

1. HDD Activity LED
2. Power button
3. Universal audio jack (with CTIA & OMTP headset support)
4. (2) Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A)
5. (2) Type-A SuperSpeed USB 10Gbps signaling rate port
6. (1) Type-C® SuperSpeed USB 20Gbps signaling rate port (optional, charge supports up to 5V/3A)
7. SD card reader 4.0 (optional)
8. Slim ODD bay
9. External 5.25" bay

Overview



rear

1. (1) Audio Line-in jack
   (1) Audio Line-out jack
2. (2) DisplayPort 1.4
3. Flex I/O module: choose one from the following:
   (1) DisplayPort 1.4, (1) HDMI 2.0b, (1) VGA, (1) Dual Type-A SuperSpeed USB 5Gbps signaling rate port, (1) Type-C® SuperSpeed USB 10Gbps signaling rate port (Power Delivery 15W, Alt Mode DisplayPort), (1) 2nd 1 GbE LAN, (1) Thunderbolt 3 with Type-C® SuperSpeed/ USB4 40Gbps signaling rate* (cabled to PCIe AIC) (1) 1Gbps Fiber LC NIC
4. (2) Hi-Speed USB 480Mbps signaling rate port
5. (2) Type-A SuperSpeed USB 10Gbps signaling rate port
   (1) Type A SuperSpeed USB 5Gbps signaling rate port
   (1) Hi-Speed USB 480Mbps signaling rate port
6. WLAN Antenna (optional)
   a. Internal
   b. External
7. RJ-45
8. 2nd serial port (optional)
9. Hood lock (optional)
10. Power connector

*Maximum speed requires DisplayPort™ and PCIe aggregation.
**Thunderbolt only support on PCI-E slot4.
Note: Onboard Display support DP1.4/HBR2. Flex I/O module Display support DP1.4/HBR3. Resolution all support up to 5120x3200 24bpp @60Hz.

Form Factor Tower

Operating Systems Preinstalled:

- Windows 11 Pro - HP recommends Windows 11 Pro[2]
- Windows 11 Home - HP recommends Windows 11 Pro[2]
- Windows 10 Pro (available through downgrade rights from Windows 11 Pro) [1,2,3]

Overview

- Linux®-ready[5]
- Ubuntu 20.04 LTS[4]

Web-supported only:

- Windows 10 Enterprise 64[2]

Supported Version:

- HP tested Windows 10, versions 20H2, 21H1 and 21H2 on this platform. For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.

[1] Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).
[2] Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
[3]This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.
[4] Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.
[5]For detailed Linux® OS/hardware support information, see:
http://www.hp.com/support/linux_hardware_matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

Processors

Name	Cores	Clock Speed (GHz)	Threads	Cache (MB)	Memory Speed (MT/s)	Hyper-Threading	Integrated Graphics	Intel® Turbo Boost Technology[3]	Featuring Intel® vPro® Technology[4]	16GB Intel® Optane™ memory[2]	TDP (W)
Intel® Core™ i9-12900K Processor	16	3.2	24	30	4800	Y	Intel® UHD Graphics 770	5.2	Y	N	125
Intel® Core™ i9-12900 Processor	16	2.1	24	30	4800	Y	Intel® UHD Graphics 770	5.1	Y	N	65
Intel® Core™ i7-12700K Processor	12	3.6	20	25	4800	Y	Intel® UHD Graphics 770	5.0	Y	N	125
Intel® Core™ i7-12700 Processor	12	2.1	20	25	4800	Y	Intel® UHD Graphics 770	4.9	Y	N	65
Intel® Core™ i5-12600K Processor	10	3.7	16	20	4800	Y	Intel® UHD Graphics 770	4.9	Y	N	125
Intel® Core™ i5-12600 processor	6	3.3	12	18	4800	Y	Intel® UHD Graphics 770	4.8	Y	N	65

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Intel® Core™ i5-12500 processor	6	3.0	12	18	4800	Y	Intel® UHD Graphics 770	4.6	Y	N	65
Intel® Core™ i5-12400 processor	6	2.5	12	18	4800	Y	Intel® UHD Graphics 730	4.4	N/A	N	65
Intel® Core™ i3-12300 processor	4	3.5	8	12	4800	Y	Intel® UHD Graphics 730	4.4	N/A	N	60
Intel® Core™ i3-12100 processor	4	3.3	8	12	4800	Y	Intel® UHD Graphics 730	4.3	N/A	N	60

[1] Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

[2] Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

[3] Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

[4] Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

Color	Black
Convertibility	No
Expansion Slots (see system board section for more details)	Slot 1: PCIe Gen5 x16 Slot 2: PCIe Gen3 x1 - with x4 Connector Slot 3: PCIe Gen3 x4 - with x16 Connector Slot 4: PCIe Gen3 x4
Expansion Bays (see storage section for more details)	(2) Internal 3.5" bays (1) External 5.25" bay (1) Internal 2.5" bay (for SSD only) (1) Dedicated 9.5mm slim optical disk drive bay
Front I/O	2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A), 2 Type-A SuperSpeed USB 10Gbps signaling rate port, 1 Type-C SuperSpeed® USB 20Gbps signaling rate port (charge supports up to 5V/3A, optional), 1 SD card reader (optional), 1 universal audio jack
Internal I/O [5]	(1) Hi-Speed USB 480Mbps signaling rate header for SD card reader (1) serial port available with header (1) serial and PS/2 available with header
Rear I/O	2 DisplayPort 1.4 [3], 1 Audio Line out, 1 Audio Line in, 1 RJ-45, 3 Hi-Speed USB 480Mbps signaling rate port, 2 Type-A SuperSpeed USB 10Gbps signaling rate port, 1 Type-A SuperSpeed USB 5Gbps signaling rate port, 1 serial (optional), 1 Flex I/O port (VGA, HDMI 2.0b, DisplayPort 1.4, Type-C® SuperSpeed USB 10Gbps signaling rate port (Power Delivery 15W, Alt Mode Display Port), Dual Tye-A SuperSpeed USB

Overview

	5Gbps signaling rate port, 2nd 1GbE LAN, 1 Thunderbolt 3 with SuperSpeed/USB4 Type-C® 40Gbps signaling rate (cabled to PCIe AIC), 1 1Gbps Fiber LC NIC
Optional I/O	Flex IO* – choose one of the following options: 1 DisplayPort™ 1.4, 1 HDMI 2.0b, 1 VGA,1 2nd 1GbE LAN, 1 1Gbps Fiber LC NIC, 1 Dual SuperSpeed USB Type-A 5Gbps signaling rate,1 SuperSpeed USB Type-C® 10Gbps signaling rate (15W USB Power Delivery, Alt Mode DisplayPort™) 1 Thunderbolt™ 3 with SuperSpeed USB4 Type-C® 40Gbps signaling rate (cabled to PCIe® AIC); Front - 1 SuperSpeed USB Type-C® 20Gbps signaling rate (1 charging), 1 SD card reader; Rear –1 serial; Front – choose one of the following options: 1 SuperSpeed USB Type-C® 20Gbps signaling rate (1 charging), 1 SD 4.0 card reader *Flex IO port and one PCIe slot will be occupied when Thunderbolt is installed. Thunderbolt will be available in Q2, 2022 (1st refresh).
Interfaces Supported	SD card reader (optional)
On-board RAID Support	SATA and NVME RAID 0 Striped Array SATA RAID and NVME RAID 1 Mirror Array
Chassis Dimensions (H x W x D)	H: 14" [356mm] W: 6.7" [169mm] D: 15.2" [385mm]
Packaged Dimensions	H: 20.39" (518mm) W: 11.61" (295mm) D: 19.29" (490mm)
Rack Dimensions	4U
Weight	Exact weights depend upon configuration (System weight only). Starting at 6.2kg (13.7lbs.)
Temperature	Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr
Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
Maximum Altitude (non-pressurized)[6]	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.
Power Supply	700W wide-ranging, active Power Factor Correction, 92% Efficiency. 500W wide-ranging, active Power Factor Correction, 90% Efficiency. 450W wide-ranging, active Power Factor Correction, 90% Efficiency. 350W wide-ranging, active Power Factor Correction, 92% Efficiency. NOTE: The Power Supply Efficiency Report for the 700W 92% Efficiency, 500W 90% Efficiency, 450W 90% Efficiency and 350W 92% Efficiency Power Supply may be found at the following links: 700W PSU: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2 500W PSU: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2 450W PSU: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2 350W PSU: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

Overview

Backup Devices	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit http://www.hp.com/go/connect
Chipset	Intel® W680 chipset
Memory	4 DIMM slots, supporting up to 128GB ECC/non-ECC, DDR5 4800 MT/s speed depending on the system configuration

Supported Components

Processors	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
12th Generation Intel® Core™ Processors*				
Intel® Core™ i9-12900K Processor	Y	N		
Intel® Core™ i9-12900 Processor	Y	N		
Intel® Core™ i7-12700K Processor	Y	N		
Intel® Core™ i7-12700 Processor	Y	N		
Intel® Core™ i5-12600K Processor	Y	N		
Intel® Core™ i5-12600 processor	Y	N		
Intel® Core™ i5-12500 processor	Y	N		
Intel® Core™ i5-12400 processor	Y	N		1
Intel® Core™ i3-12300 processor	Y	N		1
Intel® Core™ i3-12100 processor	Y	N		1

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

NOTE 1: These processors support only non-ECC memory
NOTE 2: No iGfx. A discrete graphics card must be purchased at the same time.

SATA Hard Drives	Factory Configured	Option Kit	Option Kit Part Number
500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA
1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA
2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA
1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	W0R10AA
2TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	2Z274AA
4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	K4T76AA
8TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	2Z273AA
12TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	5S461AA
500GB SATA 7.2K SED HDD	Y	Y	D8N29AA
PCIe Solid State Drives			
HP ZTurbo 256GB TLC Z2 G9 TWR/SFF SSDKit	Y	Y	141L5AA/AT
HP ZTurbo 512GB PCIe-Gen 4x4 TLC Z2 SSDKit	Y	Y	201G0AA/AT
HP ZTurbo 512GB PCIe-Gen 4x4 SED Z2 SSDKit	Y	Y	201F9AA
HP ZTurbo 1TB PCIe-Gen 4x4 TLC Z2 SSDKit	Y	Y	201F5AA/AT
HP ZTurbo 2TB PCIe-Gen 4x4 TLC Z2 SSDKit	Y	Y	201F8AA
HP ZTurbo 256GB SED Opal 2 TLC Z2 G9 TWR/SFF SSDKit	Y	Y	141M3AA/AT
Z Turbo 1TB 2280 PCIe-Gen4x4 Self Encrypted OPAL2 TLC M.2 Z2 SSD	Y	Y	223A3AA/AT
Z Turbo 2TB 2280 PCIe-Gen4x4 Self Encrypted OPAL2 TLC M.2 Z2 SSD	Y	Y	223A4AA/AT
256GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	Y	Y	4M9Z1AA

Supported Components

512GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	Y	Y	4M9Z2AA
1TB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	Y	Y	4M9Z3AA
Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 Z2 Kit SSD	Y	Y	5S492AA
Z Turbo 2TB PCIe-4x4 TLC SSD Module	Y	Y	38T75AA
Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Y	Y	38T76AA
Z Turbo 1TB PCIe-4x4 TLC SSD Module	Y	Y	38T77AA
Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Y	Y	38T79AA
Z Turbo 512GB PCIe-4x4 TLC SSD Module	Y	Y	38T80AA
Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Y	Y	38T81AA
Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD Module	Y	Y	5S496AA
Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Y	Y	5S497AA
Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z2 Kit SSD	Y	Y	5S498AA

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Graphics Cable Adapters	HP DisplayPort To HDMI True 4k Adapter	Y	Y	2JA63AA	
	HP Single miniDP-to-DP Adapter Cable	Y	Y	2MY05AA	
	HP DisplayPort To DVI-D Adapter	Y	Y	FH973AA	
	HP DisplayPort To DVI Adapter (Bulk 90)	Y	Y	FH973A6	
	HP DisplayPort To VGA Adapter	Y	Y	AS615AA/AT	
	HP DisplayPort to VGA Adapter Bulk Qty.90)	Y	Y	AS615A6	
	HP DisplayPort To VGA Adapter	Y	Y	F7W97AA	
	HP USB-C to DisplayPort Adapter	Y	Y	4SH08AA	
	HP USB-C to HDMI Adapter	Y	Y	4SH07AA	
	HP USB-C to VGA Adapter	Y	Y	4SH06AA	
Entry 3D	NVIDIA® T400 2 GB Graphics[1]	Y	Y	340K8AA	1
	NVIDIA® T400 4 GB Graphics	Y	Y	5Z7E0AA/AT	1
	NVIDIA® T600 4 GB Graphics[1]	Y	Y	340K9AA	1
	NVIDIA® T1000 4 GB MXM Graphics	Y	Y	20X22AA	1
Mid-range 3D	NVIDIA® T1000 8 GB Graphics	Y	Y	5Z7D8AA/AT	1
	NVIDIA RTX™ A2000 12GB Graphics*	Y	Y	5Z7D9AA/AT	1
	AMD Radeon™ Pro W6600 Graphics (8GB GDDR6 dedicated) *	Y	Y	340K5AA	1
High-End 3D	AMD Radeon™ RX 6700 XT Graphics (12 GB GDDR6 dedicated) *	Y	Y		1
	NVIDIA® RTX™ A4000 16 GB Graphics*	Y	Y	20X24AA/AT	1
	NVIDIA® RTX™ A4500 20 GB Graphics*	Y	Y	5S458AA/AT	1
	AMD Radeon™ Pro W6800 Graphics (32 GB GDDR6 dedicated) *	Y	Y	340K7AA	1
	NVIDIA® RTX™ A5000 24 GB Graphics*	Y	Y	20X23AA/AT	1

Note 1: NVIDIA® T400 (2 GB GDDR6 dedicated) and NVIDIA® T600 (4 GB GDDR6 dedicated) may go End of Life in late 2022.

Supported Components

* Requires 700W chassis.
** Requires at least 500W chassis.

Memory

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP 8GB (1x8GB) DDR5-4800 nECC UDIMM	Y	Y	4M9X9AA	
HP 16GB (1x16GB) DDR5-4800 nECC UDIMM	Y	Y	4M9Y0AA	
HP 16GB (1x16GB) DDR5-4800 ECC UDIMM	Y	Y	4M9Y1AA	1
HP 32GB (1x32GB) DDR5-4800 nECC UDIMM	Y	Y	4M9Y2AA	
HP 32GB (1x32GB) DDR5-4800 ECC UDIMM	Y	Y	4M9Y3AA	1

NOTE 1: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors
NOTE 2: Two channels of DDR5 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.
NOTE 3: Though the memory modules can run up to 4800MHz, the current platform will only be able to support the maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

Module Configuration	Description of configuration	Max Memory Speed (Actual Memory speed is dependent on CPU)
Single DIMM per channel	Configurations that contain only one or two DIMM modules with DIMMs only in the black slots	4400MHz
Two single ranked DIMMs in a channel	Configurations with 3 or 4 single ranked DIMMs (8GB and 16GB) installed in a system	4000MHz
Two dual ranked DIMMs in a channel	Configurations with 3 or 4 dual ranked DIMMs (32GB) installed in a system	3600MHz

Note: When more than one memory slot is populated, symmetric configurations are required for 2 DIMMs per channel. Mix of different part numbers or mix of single and dual ranks within a channel is not allowed.

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number
HP DX175 Removable HDD Frame/Carrier	Y	Y	1ZX71AA
HP DX175 Removable HDD Spare Carrier	Y	Y	1ZX72AA
HP Z2 TWR SuperMulti DVD-Writer 9.5mm Slim ODD	Y	Y	4L5K0AA
HP Z2 TWR DVD-ROM 9.5mm Slim ODD	Y	Y	4L5K1AA
HP CRU QX328 5.25 in Front Removable Frame/Carrier	Y	Y	4N011AA
HP CRU SHIPS M.2 2TB Storage Module	Y	Y	56Q87AA
HP CRU SHIPS M.2 1TB Storage Module	Y	Y	56Q88AA
HP CRU SHIPS M.2 512GB Storage Module	Y	Y	56Q89AA
HP CRU SHIPS M.2 Spare Carrier	Y	Y	633X9AA

Supported Components

NOTE: With Blu-Ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this Desktop PC.
NOTE: Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 Double Sided-Version 1.0 Media.

Networking and Communications	Factory Configured	Option Kit	Option Kit Part Number
Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.0)	Y	N	
HP 1GbE LAN Flex Port 2020	Y	Y	141J6AA/AT
HP Flex 1GbE Fiber LC Single Port	Y	Y	20J15AA
NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC[1]	Y	Y	436M8AA
NVIDIA Mellanox 10GbE SFP+ SR Transceiver[1]	Y	Y	4M9X7AA
Intel Ethernet I350-T4 4-Port 1Gb NIC*	N	Y	W8X25AA
Intel X550 10GBASE-T Dual Port NIC	Y	Y	1QL46AA
NVIDIA Mellanox 25GbE SFP28 Transceiver[1]	Y	Y	436N4AA
Intel Ethernet Network Adapter I225-T1	Y	Y	406L9AA
Intel Ethernet I350-T2 2-Port 1Gb NIC	Y	Y	V4A91AA
Intel Wi-Fi 6E AX211 BT 5.2 M.2 non-vPro[2,**]	Y	N	

*Intel I350-T4 4-port GbE NIC is an After Market Option only.
[1] Available in Q2, 2022
[2] Intel AX211 with Internal antenna support WIFI 6
[2] Intel AX211 with external antenna support WIFI 6E
**Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
NOTE: The integrated network connection is required to support Intel® vPro® Technology.
NOTE: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.
NOTE: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Supported Components

Input Devices	Factory Configured	Option Kit	Option Kit Part Number
HP USB 320K Keyboard	Y	Y	9SR37AA
HP 320M Wired Mouse	Y	Y	9VA80AA
HP Wired Desktop 320MK Mouse and Keyboard	N	Y	9SR36AA
HP 125 Wired Keyboard	Y	Y	266C9AA
HP 975 USB+BT Dual Mode Wireless	N	Y	3Z726AA
HP 655 Wireless USB BLK KBD/MSE Kit	N	Y	
HP 125 Wired Mouse	Y	Y	265A9AA
HP 128 Laser Wired Mouse	Y	Y	265D9AA
HP 935 Creator Wireless Mouse	N	Y	1D0K8AA
HP 455 Programmable Wireless Keyboard	Y	Y	4R177AA
HP 455 Programmable Wireless Keyboard (Bulk Qty.12)	Y	Y	4R177A6
HP 655 Wireless Keyboard and Mouse Combo	Y	Y	4R009AA
HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10)	Y	Y	4R009A6
HyperX Cloud MIX Wireless GAM HEADSET	N	Y	4P5K9AA
HyperX Cloud Core BLK GAM HEADSET	N	Y	4P4F2AA
HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX-HSCF-BK/AM)	N	Y	4P5L4AA
HyperX Cloud Stinger Core GAM HEADSET PC	N	Y	4P4F4AA
HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G)	N	Y	4P5P8AA

Note: Keyboard and Mouse are optional or add on features.

Flex Module (Rear IO)	Factory Configured	Option Kit	Option Kit Part Number
HP 1GbE LAN Flex Port 2020	Y	Y	141J6AA/AT
HP DP Flex Port 2020	Y	Y	141J7AA/AT
HP Dual USB-A 3.2 Gen1 Flex Port 2020	Y	Y	141J8AA/AT
HP HDMI Flex Port	Y	Y	69D47AA/AT
HP USB-C 3.2 Gen2 Alt Flex Port 2020	Y	Y	141K6AA/AT
HP VGA Flex Port 2020	Y	Y	141K7AA/AT
HP Flex 1GbE Fiber LC Single Port	Y	Y	20J15AA

Other Hardware	Factory Configured	Option Kit	Option Kit Part Number
HP Single TBT3 wType C and USB4 PCIe x4 Card	Y	N	N/A
HP Z2 Internal Serial Port and PS/2 Port	Y	Y	141K9AA/AT
HP Z2 Power Cord Kit	Y	Y	1N1D5AA
HP Z2 2nd serial port adapter	Y	Y	141K8AA/AT
HP Z2 Tower Dust Filter	Y	Y	141L2AA/AT
HP Z2 Tower Dust Filter and bezel	Y	Y	141L3AA/AT
HP PCIe x1 Parallel Port Card	Y	Y	N1M40AA
HP Z2 G9 Single Type-C SuperSpeed USB 20Gbps Front Port	Y	Y	4M9X8AA/AT
HP Z2 TWR Dual Front Fan Kit	Y	Y	4N007AA

Supported Components

[1]Available in Q3, 2021

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Z2 Mini and Z2/Z4/Z6 TWR Depth Adjustable Fixed Rail Rack Kit	Y	Y	2A8Y5AA
	HP Keyed Cable Lock	Y	Y	T1A62AA
	HP Master Keyed Cable Lock 10mm	Y	Y	T1A63AA
	HP Business PC Security Lock V3 Kit	Y	Y	3XJ17AA

Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Y	N	1
	HP PC Hardware Diagnostics UEFI (Windows OS only)	Y	N	2
	HP PC Hardware Diagnostics Windows		N	3
	HP Wolf Security	Y	N	
	HP Notifications	Y	N	
	HP Desktop Support Utility	Y	N	
	HP Documentation	Y	N	
	HP Image Assistant	N	N	
	HP Support Assistant	N	N	
	HP Quick Drop	Y	N	
	myHP	Y	N	
	HP Easy Clean	Y	N	
	HP Smart Health	Y	N	7
	Kingsoft WPS Office	Y	N	4
	My Office	Y	N	5
	Adobe Substance 3D Collection Plan	N	Y	6
	WSL2/Ubuntu Data Science Stack	Y	N	7

Notes:

1. Supports, and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor
2. Windows OS only
3. Not available in Russia
4. Only available in China
5. Only available in Russia
6. Not available in China
7. Optional Software

Operating Systems

Windows 11 Pro - HP recommends Windows 11 Pro[2]

Windows 11 Home - HP recommends Windows 11 Pro[2]

Windows 10 Pro (available through downgrade rights from Windows 11 Pro) [1,2,3]

Linux®-ready[5]

Ubuntu 20.04 LTS[4]

Supported Components

[1] Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).
[2] Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
[3]This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.
[4] Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.
[5]For detailed Linux® OS/hardware support information, see:
http://www.hp.com/support/linux_hardware_matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

Supported Components

HP BIOS

Additional HP BIOS Features:

- Power-On password – Helps prevent an unauthorized user from powering on the system.
- Administrator password – Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
  - -Power to expansion connectors / slots
  - -Most Wake events other than power buttons and WOL(Wake on LAN supported by embedded Lan controller under S4/S5 Maximum Power Saving Enabled)
  - -USB charging ports

HP Sure Start Gen7 Start

- BIOS Integrity checking – Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS – Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

Note: HP Sure Start Gen7 is available on HP Workstation products equipped with Intel® 12th generation processors.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Software

HP Support Assistant [14]
HP Image Assistant
HP Desktop Support Utility
HP Documentation
HP Notifications
HP PC Hardware Diagnostics UEFI
HP PC Hardware Diagnostics Windows
HP Performance Advisor[1]
myHP
HP QuickDrop[19]
HP Easy Clean[20]
HP Smart Health[21]
WSL/Ubuntu Data Science Stack
HP Privacy Settings
Touchpoint Customizer for Commercial

Manageability Features

Supported Components

HP Driver Packs[2]
HP UWP Pack
HP System Software Manager (SSM)
HP Manageability Integration Kit Gen4[3]
HP Smart Support[5]
HP Client Catalog (download)
HP Image Assistant (download)
HP Cloud Recovery
HP Client Management Script Library (download)
HP BIOSphere Gen6 [13]

Client Security Software
HP Client Security Suite Gen7[4] including: (including Credential Manager, HP Password Manager[6], HP Spare Key)
HP Power On Authentication
Microsoft Defender[7]

Security Management
HP Secure Erase [16]
HP Wolf Pro Security Edition (optional) [18]
HP Wolf Security for Business[22] Includes:
HP Sure Click[11]
HP Sure Sense[12]
HP Sure Run Gen5[9]
HP Sure Recover Gen4 [10]
HP Sure Start Gen7[8]
HP Tamper Lock
HP Sure Admin [17]
HP Client Security Manager Gen 7[4]

[1] HP Performance Advisor Software - HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor

[2] HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

[3] HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html

[4] HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.

[5] HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

[6] HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

[7] Microsoft Defender Opt in and internet connection required for updates.

[8] HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.

[9] HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors

[10] HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

[11] HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

Supported Components

[12] HP Sure Sense requires Windows 11 Pro or Enterprise and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
[13] HP BIOSphere Gen6 features may vary depending on the platform and configurations.
[14] HP Support Assistant requires Windows and Internet access.
[16] Secure Erase - For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.
[17] HP Sure Admin requires Windows 11, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
[18] HP Wolf Pro Security Edition is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.
[19] HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
[20] HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.
[21] HP Smart Health automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
[22] HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features

System Board

System Board Form Factor	Customized PCB 36.056 x 25.130 mm (14.197 x 9.894 inch)
Processor Socket	Single LGA-1700
CPU Bus Speed	DMI Gen4
Chipset	Intel® PCH W680
Super I/O Controller	Nuvoton SIO21
Memory Expansion Slots	4 DDR5 memory slots
Memory Type Supported	DDR5, UDIMM (Unbuffered), ECC& non-ECC
Memory Modes	Non-Interleaved for single channel. Interleaved when both channels are populated.
Memory Speed Supported	3600MT/s to 4400MT/s DDR5, dependent on memory configuration[1]

[1]Though the memory modules can run up to 4800MHz, the current platform will only be able to support the maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

Module Configuration	Description of configuration	Max Memory Speed (Actual Memory speed is dependent on CPU)
Single DIMM per channel	Configurations that contain only one or two DIMM modules with DIMMs only in the black slots	4400MHz
Two single ranked DIMMs in a channel	Configurations with 3 or 4 single ranked DIMMs (8GB and 16GB) installed in a system	4000MHz
Two dual ranked DIMMs in a channel	Configurations with 3 or 4 dual ranked DIMMs (32GB) installed in a system	3600MHz

Memory Protection	ECC available on data
Maximum Memory	128GB
Memory Configuration (Supported)	8GB, 16GB and 32GB non-ECC, 16GB and 32GB ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed in the same system
PCI Express Connectors	(1) PCI Express Gen5 slot x16 mechanical/ x16 electrical (full height, full length) (1) PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length, open-ended) (1) PCI Express Gen3 slot x16 mechanical/ x4 electrical (full height, full length) (1) PCI Express Gen3 slot x4 mechanical/ x4 electrical (full height, full length, open-ended) (1) M.2 2280 Storage (PCIe Gen4 x4) (1) M.2 2280 Storage (PCIe Gen4 x4) (1) M.2 2280 Storage (PCIe Gen4 x4) (1) M.2 2230 WLAN (PCIe Gen3 x1+ Intel CNVi) NOTE: The PCIe Gen5 x16 slot has validated and passed PCI-SIG electrical compliance test ONLY. HP does not guarantee and support any PCIe Gen5 cards in the market.
Supported Interfaces	**SATA**: Integrated (4) Serial ATA interfaces (6Gb/s SATA). RAID 0 and 1 supported. Factory integrated RAID for Microsoft Windows only. **Integrated Graphics**: Intel® UHD Graphics 730 (on Core i5-12400/i3-12300/i3-12100) processors); Intel® UHD Graphics 770 (on Core i5/i7/i9 processors); Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display.

System Technical Specifications

		Support for Microsoft DirectX 12, OpenGL 4.6 and OpenCL 3.0 on Intel® UHD Graphics 730/770; Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display. 2 DP 1.4 graphics ports integrated in motherboard; Supports up to three simultaneous displays across DisplayPort*/HDMI*/DVI outputs. Max. resolution supported on onboard DP 1.4/HBR2 ports: 4096x2304 @ 60Hz, 24bpp Max. resolution supported on FlexIO DP 1.4/HBR3 port: 5120x3200 @60Hz, 24bpp
	Network Controller	Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL, PXE 2.1 and AMT 16
	Serial	1 internal header (requires optional Serial Port and PS/2 Combo Kit with PCIe bracket)
	2nd Serial	1 internal header(requires optional Serial Port Adapter Kit)
USB Connector(s)	**Front**	2 Type-A SuperSpeed USB 10Gbps signaling rate port (charge supports up to 5V/2.1A); 2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® SuperSpeed USB 20Gbps signaling rate port (optional, charge supports up to 5V/3A)
	Rear	3 High-speed USB 480Mbps signaling rate port; 1 Type-A SuperSpeed USB 5Gbps signaling rate port; 2 Type-A SuperSpeed USB 10Gbps signaling rate port; Flex I/O option: 1 SuperSpeed USB Type-C® 10Gbps signaling rate (Power Delivery 15W, Alt Mode DisplayPort); 1 Dual SuperSpeed USB Type-A 5Gbps signaling rate
	Internal	1 High-speed USB 480Mbps signaling rate header for SD Card Reader
HD Integrated Audio	Realtek ALC3205	
Flash ROM	Yes	
CPU Fan Header	Yes	
Memory Fan Header	None	
Chassis Fan Header	1 Rear System Chassis Fan Header, 1 Graphic chassis Fan Header.	
Front PCI Fan Header	None	
Front Control Panel/Speaker Header	Yes	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	Integrated TPM 2.0 (Infineon SLB9672) Convertible to FIPS 140-2 Certified mode through firmware v15.21	
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes	
Clear Password Jumper	None	
Keyboard/Mouse	USB or PS/2 (option)	
Power Supply	700W EPA92, 500W EPA90, 450W EPA90 and 350W EPA92	

System Technical Specifications

[1]Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.
[2]M.2 storage supports compatible devices up to 80mm

System Technical Specifications

System Configurations								
Example Configuration #1	**Processor Info**	Core i5-12500,6C 3.0G 65W						
	Memory Info	2 x 8G DDR5 4800 UDIMM NECC						
	Graphics Info	NVIDIA T400 4GB						
	Disks/Optical/Floppy	512GB SSD Z Turbo						
	PSU	350W						
	Other	NA						
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	17.866		17.912		17.804		
	Windows short Idle (S0)	18.926		19.024		18.883		
	Windows Busy Typ (S0)	160.167		155.973		161.10		
	Windows Busy Max (S0)	192.557		187.067		193.063		
	Sleep (S3)	1.367	1.259	1.401	1.367	1.259	1.401	
	Off (S5)	0.555	0.552	0.561	0.555	0.552	0.561	
	Zero Power Mode (EuP)	0.171		0.173		0.168		

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	60.959		61.116		60.747		
	Windows short Idle (S0)	64.576		64.91		64.429		
	Windows Busy Typ (S0)	546.489		532.181		549.707		
	Windows Busy Max (S0)	657.003		638.271		658.732		
	Sleep (S3)	4.664	4.296	4.78	4.664	4.296	4.78	
	Off (S5)	1.894	1.883	1.914	1.894	1.883	1.914	
	Zero Power Mode (EuP)	0.583		0.59		0.573		
Example Configuration #2	**Processor Info**	Core i7-12700,12C 2.1G 65W						
	Memory Info	2 x 16G DDR5 4800 UDIMM NECC						
	Graphics Info	NVIDIA T1000 8GB						
	Disks/Optical/Floppy	512GB SSD Z Turbo						
	PSU	450W						
	Other	NA						
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	20.169		20.335		20.087		
	Windows short Idle (S0)	21.222		21.547		21.195		
	Windows Busy Typ (S0)	119.48		117.953		120.406		
	Windows Busy Max (S0)	157.13		155.03		157.833		
	Sleep (S3)	1.575	1.461	1.582	1.575	1.461	1.582	
	Off (S5)	0.944	0.941	0.952	0.944	0.941	0.952	
	Zero Power Mode (EuP)	0.204		0.207		0.202		

System Technical Specifications

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	68.817		69.383		68.537	
	Windows short Idle (S0)	72.409		73.518		72.317	
	Windows Busy Typ (S0)	407.666		402.457		410.824	
	Windows Busy Max (S0)	536.128		528.962		538.527	
	Sleep (S3)	5.374	4.985	5.398	5.374	4.985	5.398
	Off (S5)	3.221	3.211	3.248	3.221	3.211	3.248
	Zero Power Mode (EuP)	0.696		0.706		0.689	

Example Configuration #3	**Processor Info**	Core i9-12900,16C 2.4G 65W
	Memory Info	2 x 16G DDR5 4800 UDIMM ECC
	Graphics Info	NVIDIA RTX A2000
	Disks/Optical/Floppy	512GB SSD Z Turbo
	PSU	450W
	Other	NA

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	22.555		23.324		22.484	
	Windows short Idle (S0)	23.414		24.656		23.397	
	Windows Busy Typ (S0)	159.883		156.853		161.463	
	Windows Busy Max (S0)	189.99		185.89		190.127	
	Sleep (S3)	1.585	1.492	1.694	1.585	1.492	1.694
	Off (S5)	0.952	0.95	1.083	0.952	0.95	1.083
	Zero Power Mode (EuP)	0.21		0.217		0.198	

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	76.958		79.581		76.715	
	Windows short Idle (S0)	79.889		84.126		79.831	
	Windows Busy Typ (S0)	545.522		535.184		550.913	
	Windows Busy Max (S0)	648.246		634.257		648.712	
	Sleep (S3)	5.408	5.091	5.78	5.408	5.091	5.78
	Off (S5)	3.248	3.241	3.695	3.248	3.241	3.695
	Zero Power Mode (EuP)	0.717		0.74		0.676	

Example Configuration #4	**Processor Info**	Core i7-12700K,12C 3.6G 125W
	Memory Info	4 x 16G DDR5 4800 UDIMM NECC
	Graphics Info	NVIDIA RTX A4000
	Disks/Optical/Floppy	1T SSD Z Turbo
	PSU	700W
	Other	NA

System Technical Specifications

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	22.551		22.964		22.486	
	Windows short Idle (S0)	23.911		24.168		23.749	
	Windows Busy Typ (S0)	272.74		267.963		274.65	
	Windows Busy Max (S0)	322.833		316.03		323.367	
	Sleep (S3)	1.994	1.892	1.997	1.994	1.892	1.997
	Off (S5)	0.653	0.641	0.666	0.653	0.641	0.666
	Zero Power Mode (EuP)	0.215		0.217		0.212	

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	76.944		78.353		76.722	
	Windows short Idle (S0)	81.584		82.461		81.032	
	Windows Busy Typ (S0)	930.589		914.291		937.106	
	Windows Busy Max (S0)	1101.507		1078.294		1103.327	
	Sleep (S3)	6.804	6.456	6.814	6.804	6.456	6.814
	Off (S5)	2.228	2.187	2.272	2.228	2.187	2.272
	Zero Power Mode (EuP)	0.734		0.74		0.723	

Example Configuration #5		
	Processor Info	Core i9-12900K,16C 3.2G 125W
	Memory Info	4 x 32G DDR5 4800 UDIMM ECC
	Graphics Info	NVIDIA RTX A5000
	Disks/Optical/Floppy	1T SSD Z Turbo
	PSU	700W
	Other	NA

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	24.038		24.681		23.994	
	Windows short Idle (S0)	25.764		25.958		25.621	
	Windows Busy Typ (S0)	465.05		459.71		468.377	
	Windows Busy Max (S0)	467.623		438.733		474.68	
	Sleep (S3)	2.261	2.148	2.273	2.261	2.148	2.273
	Off (S5)	0.772	0.659	0.777	0.772	0.659	0.777
	Zero Power Mode (EuP)	0.318		0.319		0.315	

Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	82.018		84.212		81.868	
	Windows short Idle (S0)	87.907		88.569		87.419	
	Windows Busy Typ (S0)	1586.75		1568.531		1598.101	
	Windows Busy Max (S0)	1595.531		1496.958		1619.608	
	Sleep (S3)	7.715	7.329	7.755	7.715	7.329	7.755

System Technical Specifications

	Off (S5)	2.634	2.249	2.651	2.634	2.249	2.651
	Zero Power Mode (EuP)	1.085		1.088		1.075	

NOTE: The Power Supply Efficiency report may be found at the following links:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

System Technical Specifications

Operating Voltage Range	90-269 VAC
Rated Voltage Range	100-240 VAC
Rated Line Frequency	50-60 Hz
Operating Line Frequency Range	47-63 Hz
Rated Input Current	8.2A @ 100-240V
Heat Dissipation	Typical: 1598.101 btu/hr (402.984 kcal/hr) Maximum: 1619.608 btu/hr (408.407 kcal/hr)
ENERGY STAR® certified (Config Dependent)	Yes
CECP Compliant @ 220V	Yes
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <1W in S4/S5 - Power Off
Built-in Self Test (BIST) **LED**	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5 - Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5 - Power Off)	Yes

Declared Noise Emissions (Entry-level, Mid-level, and High-end configurations; tested on floor)			
System Configuration (Entry level)	**Processor Info**	Intel® CPU Core i5-12400 6C LGA 2.50G 18 MB 65W (Intel - Alder Lake-S)	
	Memory Info	32GB 4800 SK hynix memory	
	Graphics Info	Intel® UHD	
	Disks/Optical	1*2TB Samsung M.2 SSD	
	Power Supply	Chicony 700W EPA92	
Declared Noise Emissions		**Sound Power** (LWAd, bels)	**Deskside Sound Pressure** (LpAm, decibels)
	Idle	3.36	14.9
	Hard drive Operating (Drive Random Seek)	3.78	20.3
	Hard drive Operating (Active mode)	3.45	17.7
System Configuration (Mid-level)	**Processor Info**	Intel® CPU Core i9-12900 16C LGA 2.40G 30 MB 65W ECC (Intel - Alder Lake-S)	
	Memory Info	4* 32GB 4800 SK hynix memory	
	Graphics Info	NVIDIA® RTX A5000	
	Disks/Optical	3*2TB Samsung M.2 SSD; 2*WD 2TB 7200RPM SATA HDD	
	Power Supply	Chicony 700W EPA92	

System Technical Specifications

Declared Noise Emissions		**Sound Power** (LWAd, bels)	**Deskside Sound Pressure** (LpAm, decibels)
	Idle	3.59	18.5
	Hard drive Operating (Drive Random Seek)	3.82	20.1
	Hard drive Operating (Active mode)	3.97	23.6
System Configuration (High-end)	**Processor Info**	Intel® Core i9-12900K 16C 3.20G LGA 30 MB 125W ECC (Intel - Alder Lake-S)	
	Memory Info	4* 32GB 4800 SK hynix memory	
	Graphics Info	NVIDIA® RTX A5000	
	Disks/Optical	3*2TB Samsung M.2 SSD; 2*WD 2TB 7200RPM SATA HDD	
	Power Supply	Chicony 700W EPA92	
Declared Noise Emissions		**Sound Power** (LWAd, bels)	**Deskside Sound Pressure** (LpAm, decibels)
	Idle	3.58	18.2
	Hard drive Operating (Drive Random Seek)	3.78	20
	Hard drive Operating (Active mode)	4.05	20.9

Environmental Requirements	**Temperature**	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
	Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Cooling for details.
	Dynamic	Shock Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz
	Cooling	Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation, up to 3048 m (10,000 feet)

Physical Security and Serviceability

Access Panel	Tool-less Includes support information
Optical Drive	Tool-less, except for Screw-In carrier
Hard Drives	Tool-less, except for 2.5" bay
Expansion Cards	Tool-less

System Technical Specifications

Processor Socket	Tool-less, except for the processor heatsink
Blue User Touch Points	Yes, on tool-less internal chassis mechanisms
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.
Rear Port Control Cover	No
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Internal Speaker	Yes
Power Supply Fans	70mm x 70mm x 25mm 4-wire PWM (non-serviceable)
Access Panel Key Lock	No
Integrated Chassis Handles	Rear Recessed Handle
Power Supply	Requires T15 Torx or flat blade screwdriver
PCI Card Retention	Yes, rear (all), middle (optional), front (full-length cards with extender)

Service, Support, and Warranty

On-site Warranty and Service[1]: Three-years, limited warranty and service offering delivers on-site, next business-day[2] service for parts and labor and includes free telephone support[3] 8am - 5pm. Global coverage[2] ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.
NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.
HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

BIOS

BIOS 64-bit Services	BIOS supports 64-bit Operating systems only.
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.

System Technical Specifications

BBS	BIOS Boot Specification v1.01.(Not support)
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.(Not Support)
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 3.4, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes: • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 6.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 15 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.

System Technical Specifications

Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
UEFI Specification Revision	2.7
ACPI	Advanced Configuration and Power Management Interface, Version 6.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0(Not support)
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Ready
PMM	POST Memory Manager Specification, Version 1.01
SATA	Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
SPD	JEDEC JESD300-5
TPM	Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification Universal Serial Bus Revision 3.2 Specification
SMBIOS	System Management BIOS Reference Specification, Version 3.4 External BIOS simulator found at: http://csrsml.itcs.hp.com/

Social and Environmental Responsibility

Eco-Label Certifications & Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO Certified
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label*

System Technical Specifications

Sustainable Impact Specifications

- Ocean-bound plastic in System FAN, CPU FAN and Speaker
- 50% post-consumer recycled plastic
- Low halogen
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
- Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable
- Bulk packaging available

System Configuration The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)	**115VAC, 60Hz**	**230VAC, 50Hz**	**100VAC, 50Hz**
Normal Operation (Sort idle)	34.16 W	34.01 W	34.39 W
Normal Operation (Long idle)	32.77 W	32.74 W	33.15 W
Sleep	2.57 W	2.54 W	2.57 W
Off	0.67 W	0.68 W	0.67 W

Note:
Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	**115VAC, 60Hz**	**230VAC, 50Hz**	**100VAC, 50Hz**
Normal Operation (Short idle)	116.8 BTU/hr	116.3 BTU/hr	117.6 BTU/hr
Normal Operation (Long idle)	112.1 BTU/hr	112 BTU/hr	113.4 BTU/hr
Sleep	8.8 BTU/hr	8.7 BTU/hr	8.8 BTU/hr
Off	2.3 BTU/hr	2.3 BTU/hr	2.3 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L_{WAd}, bels)	Sound Pressure (L_{pAm}, decibels)
Typically Configured – Idle	3.36	14.9
Fixed Disk – Random writes	3.78	20.3
Optical Drive – Sequential reads	5.00	33.4

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

System Technical Specifications

Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.

Batteries

This battery in this product complies with EU Directive 2006/66/EC
Battery size: CR2032 (coin cell)
Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40 ppm by weight

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 94.8% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Corrugated	1214 g
	PAPER/Molded Pulp	890 g
Internal:	PLASTIC/Polyethylene low density - LDPE	40 g

The plastic packaging material contains at least 0.0% recycled content.

The corrugated paper packaging materials contains at least 62.5% recycled content.

RoHS Compliance

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium

- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

System Technical Specifications

HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	• Percentage of ocean-bound plastic contained in each component varies by product • Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. • External power supplies, WWAN modules, power cords, cables and peripherals excluded. • 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. • Fiber cushions made from 100% recycled wood fiber and organic materials.

Technical Specifications - Processors

Name	Cores	Clock Speed (GHz)	Threads	Cache (MB)	Memory Speed (MT/s)	Hyper-Threading	Integrated Graphics	Intel® Turbo Boost Technology[3]	Featuring Intel® vPro® Technology[4]	16GB Intel® Optane™ memory[2]	TDP (W)
Intel® Core™ i9-12900K Processor	16	3.2	24	30	4800	Y	Intel® UHD Graphics 770	5.2	Y	N	125
Intel® Core™ i9-12900 Processor	16	2.1	24	30	4800	Y	Intel® UHD Graphics 770	5.1	Y	N	65
Intel® Core™ i7-12700K Processor	12	3.6	20	25	4800	Y	Intel® UHD Graphics 770	5.0	Y	N	125
Intel® Core™ i7-12700 Processor	12	2.1	20	25	4800	Y	Intel® UHD Graphics 770	4.9	Y	N	65
Intel® Core™ i5-12600K Processor	10	3.7	16	20	4800	Y	Intel® UHD Graphics 770	4.9	Y	N	125
Intel® Core™ i5-12600 processor	6	3.3	12	18	4800	Y	Intel® UHD Graphics 770	4.8	Y	N	65
Intel® Core™ i5-12500 processor	6	3.0	12	18	4800	Y	Intel® UHD Graphics 770	4.6	Y	N	65
Intel® Core™ i5-12400 processor	6	2.5	12	18	4800	Y	Intel® UHD Graphics 730	4.4	N/A	N	65
Intel® Core™ i3-12300 processor	4	3.5	8	12	4800	Y	Intel® UHD Graphics 730	4.4	N/A	N	60
Intel® Core™ i3-12100 processor	4	3.3	8	12	4800	Y	Intel® UHD Graphics 730	4.3	N/A	N	60

[1] Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

[2] Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

[3] Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

[4] Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

Technical Specifications - Hard Drives

SATA Hard Drives for HP Workstations	**500GB SATA 7200 rpm 6Gb/s 3.5" HDD**	**Capacity**	500GB	
		Protocol	SATA	
		Form Factor	3.5"	
		Controller	AHCI	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NCQ enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
		Buffer	32MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2 ms *
			Average	11 ms *
			Full Stroke	21 ms *
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	1TB	
		Protocol	SATA	
		Form Factor	3.5"	
		Controller	AHCI	
		Height	1 in; 2.54 cm	
		Width	**Media Diameter**	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NCQ enabled	
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s *	
		Buffer	64MB	
		Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2 ms *
			Average	11 ms *
			Full Stroke	21 ms *
		Rotational Speed	7,200 rpm	
		Logical Blocks	1,953,525,168	
		Operating Temperature	41° to 131° F (5° to 55° C)	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	**Capacity**	2TB	
		Protocol	SATA	
		Form Factor	3.5"	
		Controller	AHCI	

Technical Specifications - Hard Drives

	Annualized Failure Rate (based on Rated POH)	<0.62%	
	Height	1 in; 2.54 cm	
	Width	**Media Diameter**	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0 Gb/s), NCQ Enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
	Buffer	64MB	
	Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	2.0 ms *
		Average	11 ms *
		Full Stroke	21 ms *
	Rotational Speed	7,200 rpm	
	Logical Blocks	3,907,029,168	
	Operating Temperature	41° to 131° F (5° to 55° C)	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	**Capacity**	1TB	
	Height	1 in; 2.54 cm	
	Protocol	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability	2.0M hours	
	Rated Power On Hours	8760/yr	
	Annualized Failure Rate (based on Rated POH)	<0.62%	
	Width	**Media Diameter**	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0 Gb/s), NCQ Enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
	Buffer	128MB	
	Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	0.32ms*
		Average	7.45ms*
		Full Stroke	14.2ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	41° to 140° F (5° to 60° C)	
	Performance	**Sequential Read**	up to 226MB/s*
		Sequential Write	up to 226MB/s*
	Enterprise Class Features	High Reliability	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

	Capacity	2TB

Technical Specifications - Hard Drives

2TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	**Protocol**	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability (MTBF)	2.0M hours	
	Rated Power On Hours	8760/yr	
	Annualized Failure Rate (based on Rated POH)	<0.62%	
	Rated for 24/7/365 Operation		
	Physical Size (Height)	1 in; 2.54 cm	
	Physical Size (Width)	4 in; 10.17 cm	
	Media Diameter	3.5 in; 8.9 cm	
	Interface	Serial ATA (6Gb/s), NCQ enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Buffer	128MB	
	Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	0.7ms*
		Average	8.5ms*
		Full Stroke	15.7ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	41° to 131° F (5° to 55° C)	
	Performance	**Sequential Read**	up to 226MB/s*
		Sequential Write	up to 226MB/s*
	Enterprise Class Features	High Reliability	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	**Capacity**	4TB
	Protocol	SATA
	Form Factor	3.5"
	Controller	AHCI
	Reliability	2.0M hours
	Rated Power On Hours	8760/yr
	Annualized Failure Rate (based on Rated POH)	<0.62%
	Rated for 24/7/365 Operation	
	Physical Size (Height)	1 in; 2.54 cm
	Physical Size (Width)	4 in; 10.17 cm
	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6Gb/s), NCQ enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*
	Buffer	256MB

	Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	0.7ms*
		Average	8.5ms*
		Full Stroke	15.7ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	41° to 131° F (5° to 55° C)	
	Performance	**Sequential Read**	up to 226MB/s*
		Sequential Write	up to 226MB/s*
	Enterprise Class Features	High Reliability	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

8TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	**Capacity**	8TB	
	Protocol	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability	2.0M hours	
	Width	**Media Diameter**	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), NCQ enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s [1]	
	Buffer	256MB	
	Seek Time (typical reads, includes controller overhead, including settling)	**Single Track**	0.7ms*
		Average	8.5ms*
		Full Stroke	15.7ms*
	Rotational Speed	7,200 rpm	
	Operating Temperature	41° to 140° F (5° to 60° C)	
	Performance	**Sequential Read**	up to 226MB/s[1]
		Sequential Write	up to 226MB/s[1]
	Enterprise Class Features	High Reliability	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

500GB SATA 7.2K SED 2.5" HDD	**Capacity**	500GB	
	Protocol	SATA	
	Form Factor	2.5"	
	Height	0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6.0Gb/s), NCQ enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s*	
	Buffer	64MB	
		Single Track	1ms*

	Seek Time (typical reads, includes controller overhead, including settling)	**Average**	4.2ms*
		Full Stroke	25ms (Typical)*
	Rotational Speed	7,200 rpm	
	Operating Temperature	32° to 131° F (0° to 60° C)	
	Self-Encrypting Drive Support	Yes	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 512GB TLC PCIe SSD (Z2G9)	**Capacity**	512GB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	150TBW (TB Written)	
	Reliability (MTBF)	1.5M hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6400MB/s*
		Sequential Write	3400MB/s*
		Random Read	600K IOPS*
		Random Write	600K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 1TB TLC PCIe SSD (Z2G9)	**Capacity**	1TB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	300TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	800K IOPS*
		Random Write	800K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

	Capacity	2TB

Technical Specifications - Hard Drives

HP Z Turbo Drv PCIE-4X4 2TB TLC PCIe SSD (Z2G9)	**Protocol**	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	600TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	800K IOPS*
		Random Write	800K IOPS*

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 4TB TLC PCIe SSD	**Capacity**	4TB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	1200TBW (TB Written)	
	Reliability (MTBF)	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	700K IOPS*
		Random Write	700K IOPS*

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE Gen4x4 4TB TLC PCIe SED OPAL2	**Capacity**	4TB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	1200TBW (TB Written)	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	700K IOPS*
		Random Write	700K IOPS*

	Self-Encrypting Drive Support	OPAL2	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv 512GB TLC PCIe SED OPAL2 (Z2G9)	**Capacity**	512GB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	150TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6400MB/s*
		Sequential Write	3400MB/s*
		Random Read	600K IOPS*
		Random Write	600K IOPS*
	Self-Encrypting Drive Support	OPAL2	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv 1TB TLC PCIe SED OPAL2 (Z2G9)	**Capacity**	1TB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	300TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	800K IOPS*
		Random Write	800K IOPS*
	Self-Encrypting Drive Support	OPAL2	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv 2TB TLC PCIe SED OPAL2 (Z2G9)	**Capacity**	2TB
	Protocol	PCIe
	Form Factor	M.2 in native Slot on motherboard

	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	600TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 178° F (0° to 81° C)	
	Performance	**Sequential Read**	6500MB/s*
		Sequential Write	5000MB/s*
		Random Read	800K IOPS*
		Random Write	800K IOPS*
	Self-Encrypting Drive Support	OPAL2	

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

256GB 2280 PCIe-4x4 Value M.2 SSD	**Capacity**	256GB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	200TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	**Sequential Read**	3100MB/s*
		Sequential Write	1400MB/s*
		Random Read	200K IOPS*
		Random Write	400K IOPS*

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

512GB 2280 PCIe-4x4 Value M.2 SSD	**Capacity**	512GB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	300TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	**Sequential Read**	3400MB/s*
		Sequential Write	2500MB/s*
		Random Read	380K IOPS*
		Random Write	430K IOPS*

Technical Specifications - Hard Drives

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB 2280 PCIe-4x4 Value M.2 SSD	**Capacity**	1TB	
	Protocol	PCIe	
	Form Factor	M.2 in native Slot on motherboard	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability	1.5M Hours	
	Interface	PCI Express 4.0 x4 electrical	
	Operating Temperature	32° to 158° F (0° to 70° C)	
	Performance	**Sequential Read**	3400MB/s*
		Sequential Write	2500MB/s*
		Random Read	500K IOPS*
		Random Write	440K IOPS*

*Actual performance may vary.
NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Technical Specifications - Graphics

AMD Radeon™ Pro W6600 8GB Graphics	**Form Factor**	Single slot, full-height, 9.5" length
	Graphics Controller	Navi23 architecture Power: 122 Watts Cooling Solution: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x8
	Memory	8GB GDDR6 Memory Memory Bandwidth: 224 GB/s Memory Interface: 128 bit
	Connectors	4x DisplayPort™ 1.4 with DSC - HDR Ready - Supports Multi-Stream Transport (MST)
	Max simultaneous displays	@ 60Hz with HDR Enabled 4x @ 3840x2160px (4K) 4x @ 5120x2880px (5K) 1x @ 7680x4320px (8K)
	Shading Architecture	DirectX 12 Shader Model 6.5
	Supported Graphics APIs	DirectX®12 Ultimate OpenGL® 4.6 OpenCL™ 2.1 Vulkan™ 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html

AMD Radeon™ Pro W6800 32GB Graphics	**Form Factor**	Double slot, full-height, 10.5” length
	Graphics Controller	Navi21 architecture Power: 261 Watts Cooling Solution: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x16
	Memory	8GB GDDR6 Memory Memory Bandwidth: 512 GB/s Memory Interface: 256 bit
	Connectors	6x Mini-DisplayPort™ 1.4 with DSC - HDR Ready - Supports Multi-Stream Transport (MST)
	Max simultaneous displays	@ 60Hz with HDR Enabled 6x @ 3840x2160px (4K) 6x @ 5120x2880px (5K) 2x @ 7680x4320px (8K)
	Shading Architecture	DirectX 12 Shader Model 6.5
	Supported Graphics APIs	DirectX®12 Ultimate OpenGL® 4.6 OpenCL™ 2.1 Vulkan™ 1.2

Technical Specifications - Graphics

NVIDIA® T400 2GB Graphics	**Form Factor**	Single Slot, Low Profile (2.7" H x 6.1" L)
	Graphics Controller	Turing architecture Max Power: 30 Watts Cooling Solution: Active fan heatsink
	Bus Type	PCI Express 3.0 x16
	Memory	2GB GDDR6 Memory Memory Bandwidth: 80 GB/s Memory Interface: 64 bit
	Connectors	3x mDP (Mini DisplayPort™) 1.4 Connectors
	Max simultaneous displays	- 3x 3840 x 2160 @ 120Hz - 3x 5120 x 2880 @ 60Hz - supports Multi-Stream Transport (MST)
	Shading Architecture	DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html

NVIDIA® T400 4GB Graphics	**Form Factor**	Single Slot, Low Profile (2.7" H x 6.1" L)
	Graphics Controller	Turing architecture Max Power: 30 Watts Cooling Solution: Active fan heatsink
	Bus Type	PCI Express 3.0 x16
	Memory	4GB GDDR6 Memory Memory Bandwidth: 80 GB/s Memory Interface: 64 bit
	Connectors	3x mDP (Mini DisplayPort™) 1.4 Connectors
	Max simultaneous displays	- 3x 3840 x 2160 @ 120Hz - 3x 5120 x 2880 @ 60Hz - supports Multi-Stream Transport (MST)
	Shading Architecture	DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions)

		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® T600 4GB Graphics	**Form Factor**	Single Slot, Low Profile (2.7" H x 6.1" L)
	Graphics Controller	Turing architecture Max Power: 40 Watts Cooling Solution: Active fan heatsink
	Bus Type	PCI Express 3.0 x16
	Memory	4GB GDDR6 Memory Memory Bandwidth: 160 GB/s Memory Interface: 128 bit
	Connectors	4x mDP (Mini DisplayPort™) 1.4 Connectors
	Max simultaneous displays	- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz - supports Multi-Stream Transport (MST)
	Shading Architecture	DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® T1000 4GB Graphics	**Form Factor**	Single Slot, Low Profile (2.7" H x 6.1" L)
	Graphics Controller	Turing architecture Max Power: 50 Watts Cooling Solution: Active fan heatsink
	Bus Type	PCI Express 3.0 x16
	Memory	4GB GDDR6 Memory Memory Bandwidth: 160 GB/s Memory Interface: 128 bit
	Connectors	4x mDP (Mini DisplayPort™) 1.4 Connectors
	Max simultaneous displays	- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz - supports Multi-Stream Transport (MST)
	Shading Architecture	DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2

Technical Specifications - Graphics

		API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® T1000 8GB Graphics	**Form Factor**	Single Slot, Low Profile (2.7" H x 6.1" L)
	Graphics Controller	Turing architecture Max Power: 50 Watts Cooling Solution: Active fan heatsink
	Bus Type	PCI Express 3.0 x16
	Memory	8GB GDDR6 Memory Memory Bandwidth: 160 GB/s Memory Interface: 128 bit
	Connectors	4x mDP (Mini DisplayPort™) 1.4 Connectors
	Max simultaneous displays	- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz - supports Multi-Stream Transport (MST)
	Shading Architecture	DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® RTX™ A2000 12GB Graphics	**Form Factor**	Low-Profile Double Slot (2.7" H x 6.1" L)
	Graphics Controller	Ampere architecture Power: 70 Watts Cooling: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x16
	Memory	12GB GDDR6 memory Memory Bandwidth: 288 GB/s Memory Interface: 192 bit Support Error-correcting code (ECC)
	Connectors	4x mDP (Mini DisplayPort™) 1.4 Connectors

Technical Specifications - Graphics

	Max simultaneous displays	4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz 2x 7680 x 4320 @ 60 Hz
	Shading Architecture	Shader Model 6.5
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® RTX™ A4000 16GB Graphics	**Form Factor**	Full Height Single Slot (9.5” Length)
	Graphics Controller	Ampere architecture Power: 140 Watts Cooling: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x16
	Memory	16GB GDDR6 memory Memory Bandwidth: 448 GB/s Memory Interface: 256 bit Support Error-correcting code (ECC)
	Connectors	4x DP 1.4 Connectors
	Max simultaneous displays	4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz, 2x 7680 x 4320 @ 60 Hz
	Shading Architecture	Shader Model 6.5
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® RTX™ A4500 20GB Graphics	**Form Factor**	Full Height Double Slot (10.5” Length)
	Graphics Controller	Ampere architecture Power: 200 Watts Cooling: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x16

Technical Specifications - Graphics

	Memory	20GB GDDR6 memory Memory Bandwidth: 640 GB/s Memory Interface: 320 bit Support Error-correcting code (ECC)
	Connectors	4x DP 1.4 Connectors
	Max simultaneous displays	4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz, 2x 7680 x 4320 @ 60 Hz
	Shading Architecture	Shader Model 6.5
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
NVIDIA® RTX™ A5000 24GB Graphics	**Form Factor**	Full Height Double Slot (10.5” Length)
	Graphics Controller	Ampere architecture Power: 230 Watts Cooling: Active Fan Heatsink
	Bus Type	PCI Express 4.0 x16
	Memory	24GB GDDR6 memory Memory Bandwidth: 768 GB/s Memory Interface: 384 bit Support Error-correcting code (ECC)
	Connectors	4x DP 1.4 Connectors
	Max simultaneous displays	4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz, 2x 7680 x 4320 @ 60 Hz
	Shading Architecture	Shader Model 6.5
	Supported Graphics APIs	OpenGL 4.6 DirectX 12 Vulkan 1.2 API support includes: CUDA, OpenCL 1.2
	Available Graphics Drivers	Windows 10 64-bit Windows 11 64-bit Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html

Technical Specifications - Graphics

HP 9.5mm Slim DVD Writer	**Description**	9.5mm height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	128 x 9.5 x 127mm	
	Supported Media Types	DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
	Disc Capacity	**DVD-ROM**	8.5 GB DL or 4.7 GB standard
	Access Times	**Full Stroke DVD**	< 200 ms (seek)
		Full Stroke CD	< 200 ms (seek)
	Maximum Data Transfer Rates	**CD ROM Read**	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Power	**Source**	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental (all conditions non-condensing)	**Temperature**	41° to 122° F (5° to 50° C)
		Relative Humidity	10% to 80%
		Maximum Wet Bulb Temperature	84° F (29° C)
	Operating Systems Supported	Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Linux®.	
	Kit Contents	HP SATA DVD Writer drive, installation guide.	
	Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT	

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

Technical Specifications - Graphics

HP 9.5mm Slim DVD-ROM Drive	**Description**	9.5mm height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA / ATAPI	
	Dimensions (WxHxD)	128 x 9.5 x 127mm	
	Disc Capacity	**DVD-ROM**	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB
	Access Times	**DVD-ROM Single Layer**	< 110 ms (typical)
		CD-ROM Mode 1	< 110 ms (typical)
		Full Stroke DVD	< 230 ms (typical)
		Full Stroke CD	< 220 ms (typical)
	Power	**Source**	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC – <800mA typical, < 1600 mA maximum
	Operating Environmental (all conditions non-condensing)	**Temperature**	41° to 122° F (5° to 50° C)
		Relative Humidity	10% to 80%
		Maximum Wet Bulb Temperature	84° F (29° C)
	Operating Systems Supported	Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Linux®.	
	Kit Contents	9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation guide	
	Approvals	USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT	

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

Technical Specifications - Networking and Communications

Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.0[1])	**Connector**	RJ-45
	Cabling	Twisted pair up to 100m
	Controller	Intel® I219LM GbE platform LAN connect networking controller
	Memory	3 KB Tx and 3KB Rx FIFO packet buffer memory
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z
	Bus Architecture	PCI Express and SMBus
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	vPro®, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI, Advanced cable diagnostic, loopback modes, AMT 16.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

[1]Requires activation and a system with a corporate network connection, an Intel® AMT enabled chipset, and network hardware and software. For notebooks, Intel AMT may be unavailable or limited over a host OS-based VPN, when connecting wirelessly, on battery power, sleeping, hibernating, or powered off. Results dependent upon hardware, setup, and configuration. For more information, visit: https://www.intel.com/content/www/us/en/architecture-and-technology/intel-active-management-technology.html

HP 1-Port 1GbE Flex IO NIC	**Connector**	RJ-45
	Cabling	1GbE over Category 5e (or better) up to 100m
	Controller	Realtek RTL8153
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.3 (LAN) 802.3u (100BASE-TX) 802.3ab (1000BASE-T) 802.3x (Ethernet Flow Control) 802.1Q (Virtual LAN) 802.3az (Energy Efficient Ethernet)
	Bus Architecture	USB
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps

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		100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	1.5 in x 1.5 in. x 0.75 in (3.81 cm x 3.81 cm x 1.9 cm)
	Operating System Driver Support	Windows 11 64-bit Windows 10 64-bit Linux®

Intel® X550-T2 2-Port 10GbE NIC	**Connector**	Dual-port RJ-45
	Cabling	10GbE: Cat6a (or better) up to 100m 5GbE and below: Cat5e (or better) up to 100m
	Controller	Intel® Ethernet Controller X550
	Network Transfer Rates Supported	10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE
	Data Path Width	PCIe Gen3x4
	Power Requirement	11.2W (typical) 13.0 (Maximum)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	5.1 x 2.7 in (without brackets)
	Operating System Driver Support	Windows 11 64-Bit Windows 10 64-bit Linux®
	Kit Contents	• Intel® X550-T2 2-Port 10GbE NIC with standard height bracket attached • Low-profile bracket • Product Literature

NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC	**Connector**	Dual-port SFP28
	Cabling	Transceiver with Multi-Mode Fiber OM3 or OM4)
	Controller	ConnectX-6 Dx
	Network Transfer Rates Supported	1/10/25 GbE
	Data Path Width	PCIe Gen4x8
	Power Requirement	19.74W Maximum power available through SFP28 port: 2.5W (each port)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	6.22in. x 2.67in (158mm x 68mm)
	Operating System Driver	Windows 11 64-Bit Windows 10 64-bit Linux®
	Kit Contents	• NVIDIA Mellanox ConnectX-6 SFP28 25GbE NIC with standard height bracket attached • Low-profile bracket • Product Literature

NOTE: The NVIDIA Mellanox ConnectX-6 DX network adapter requires either a PCIeG4 x4 or PCIeG4 x8 slot (electrical connection) to have full performance with two 25GbE SFP28 transceivers installed in the network adapter. When the network adapter is installed in a PCIeG3 x4 slot, the performance will

	be limited when installing two 25GbE SFP28 transceivers or installing a 25GbE SFP28 transceiver plus a 10GbE SFP+ transceiver	
NVIDIA Mellanox 25GbE SFP28 Transceiver	**Operating Temperature**	32°F to 158°F (0°C to 70°C)
	Operating Humidity	5% to 85%, noncondensing
	Dimensions (HxWxD)	0.47 x 0.54 x 2.22 inches
	Kit Contents	NVIDIA Mellanox 25GbE SFP28 Transceiver
NVIDIA Mellanox 10GbE SFP+ SR Transceiver	**Operating Temperature**	32°F to 158°F (0°C to 70°C)
	Operating Humidity	5% to 85%, noncondensing
	Dimensions (HxWxD)	0.47 x 0.54 x 2.22 inches
	Kit Contents	NVIDIA Mellanox 10GbE SFP+ SR Transceiver
Intel® I350-T2 2-Port 1GbE NIC	**Connector**	2 RJ-45
	Cabling	Cat5e (or better) up to 100m
	Controller	Intel® Ethernet I350 Controller
	Network Transfer Rates Supported	1GbE, 100MbE, 10MbE
	Data Path Width	PCIe Gen2.1x4
	Power Requirement	4.4W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	2.75 x 5.5 inches (without brackets)
	Operating System Driver Support	Windows 11 Windows 10 Linux®
	Kit Contents	• Intel® I350-T2 2-Port 1GbE NIC with standard height bracket attached • Low-profile bracket • Product Literature
Intel® I350-T4 4-Port 1GbE NIC	**Connector**	4 RJ-45
	Cabling	Cat5e (or better) up to 100m
	Controller	Intel® Ethernet I350 Controller
	Network Transfer Rates Supported	1GbE, 100MbE, 10MbE
	Data Path Width	PCIe Gen2.1x4
	Power Requirement	5W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	2.75 x 5.5 inches (without brackets)
	Operating System Driver Support	Windows 11 Windows 10 Linux®
	Kit Contents	• Intel® I350-T4 4-Port 1GbE NIC with standard height bracket attached • Low-profile bracket

- Product Literature

HP Flex 1GbE Fiber LC Single Port	**Connector**	Fiber
	Cabling	1GbE over Category OM1 (or better) up to 100m
	Controller	Microchip LAN7801
	Data Rates Supported	100/1000 Mbps
	Compliance	IEEE 802.1p priority encoding/tagging (QoS, CoS) IEEE 802.1q VLAN tagging IEEE 802.3x flow control
	Bus Architecture	USB
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex
	Network Transfer Rate	100BASE-X (half-duplex) 100 Mbps 1000BASE-X (half-duplex) 1000 Mbps 1000BASE-X (full-duplex) 2000 Mbps
	Operating Temperature	32° to 158° F (0°C to 70°C)
	calvin	1.5 in x 1.7 in. x 0.75 in (3.84 cm x 4.3 cm x 1.9 cm)
	Operating System Driver Support	Windows 11 64-Bit Windows 10 64-bit Linux®
Intel® I225-T1 1-Port 2.5GbE NIC	**Connector**	RJ-45
	Cabling	Cat5e (or better) up to 85m
	Controller	Intel® Ethernet I225 Controller
	Network Transfer Rates Supported	2.5GbE, 1GbE, 100MbE, 10MbE
	Data Path Width	PCIe Gen3.1x1
	Power Requirement	1.9W (typical)
	Operating Temperature	32° to 158° F (0°C to 70°C)
	Dimensions (HxW)	2.7 in x 2.57 in. (68.7mm x 65.3mm)
	Operating System Driver	Windows 11 64-Bit Windows 10 64-bit Linux®
	Kit Contents	• Intel® I225-T1 1-Port 2.5GbE NIC with standard height bracket attached Low-profile bracket • Product Literature
Intel® Wi-Fi 6E* AX211 802.11ax, BT 5.2, M.2 With Internal Antenna	**WLAN Standards**	802.11abgn+acR2+axR2(Pre-Standard) MIMO 2x2 High performance, low power dual band Pre-Standard-802.11ax R2 2x2, both with 160MHz channel support – Wi-Fi 6E
	Antenna	2x2 Dual-Band (internal)
	Bluetooth Standards	5.2
	Operating Temperature	32° to 176° F (0° to 80° C)
	Interface	M.2 CNVio2

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	Dimensions	M.2 2230
	Kit Contents	Not Available

NOTE: The AX211 with internal antenna only support WIFI 6
*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Intel® Wi-Fi 6E* AX211 802.11ax, BT 5.2, M.2 With External Antenna	**WLAN Standards**	802.11abgn+acR2+axR2(Pre-Standard) MIMO 2x2 High performance, low power dual band Pre-Standard-802.11ax R2 2x2, both with 160MHz channel support – Wi-Fi 6E
	Antenna	2x2 Dual-Band (External)
	Bluetooth Standards	5.2
	Operating Temperature	32° to 176° F (0° to 80° C)
	Interface	M.2 CNVio2
	Dimensions	M.2 2230
	Kit Contents	ANTENNA, External, Dipole, WLAN, WIFI 6E

NOTE: The AX211 with external antenna support WIFI 6E
*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Date of change:	Version History:		Description of change:
March 8, 2022	From v1 to v2	Changed	Format
March 16, 2022	From v2 to v3	Changed	Social and Environmental Responsibility section